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6/12/02

Attorney Docket No.: P64C1-US
Express Mail No.: EL 438390712US

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In the application of: Khandros et al.
Application No.: Not known
Filing Date: October 4, 2001
For: ELECTRONIC COMPONENT
OVERLAPPING DICE OF
UNSINGULATED SEMICONDUCTOR
WAFER

Examiner: Not Known
Group Art Unit: Not Known

PRELIMINARY AMENDMENT

Box: Patent Application
Assistant Commissioner for Patents
Washington, D.C. 20231

Sir:

Prior to examination of the above-identified patent application filed concurrently herewith, please amend the application as follows:

In the Title:

Please replace the current title with the following title:

--ELECTRONIC COMPONENT OVERLAPPING DICE OF UNSINGULATED
SEMICONDUCTOR WAFER--

In the Specification:

Please replace the paragraph on page 1, lines 8-22 with the following paragraph:

This application is a continuation of application serial no. 09/114,589, filed July 13, 1998.